TOSHIBA Photocoupler GaAlAs Ired & Photo-Diode Array

TLP590B

Telecommunications
Programmable Controllers
MOS Gate Drivers
MOSFET Gate Drivers

The TOSHIBA TLP590B consists of an aluminum gallium arsenide infrared emitting diode optically coupled to a series-connected photo-diode array in a six-lead plastic DIP package.

The TLP590B is suitable for MOSFET gate drivers.

• UL recognized: UL1577, file No. E67349

Short Current

Туре	Classification	Short Current		Classification	
Type Name	Classification	(min)			
TLP590B	C20	20 μΑ	10 mΔ	20	
1EI 330B	Standard	12 µA	TOTILA	20, blank	

Note: When applying for a safety standard approval, use the type name of the standard device. TLP590B(C20): TLP590B

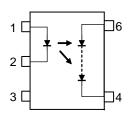
Unit: mm 3 2 1 4 6 7.12 ± 0.25 28 80 0.25 0.05 0.5 ± 0.1 1.2 ± 0.15 28 2.54 ± 0.25 0.5 ± 0.1 1.7A9

11-7A9

Weight: 0.39 g (typ.)

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Pin Configuration (Top View)



- 1: Anode(LED)
- 2: Cathode(LÉD)
- 3: N.C.
- 4: Cathode
- 6: Anode

Absolute Maximum Ratings (Ta = 25°C)

	Characteristics	Symbol	Rating	Unit
	Forward current	lF	50	mA
	Forward current derating (Ta ≥ 25°C)	ΔIF/°C	-0.5	mA / °C
0	Pulse forward current (100 µs pulse, 100 pps)	lFP	1	Α
LED	Reverse voltage	V_{R}	3	V
	Diode power dissipation	PD	100	mW
	Diode power dissipation derating (Ta ≥ 25°C)	ΔP _D /°C	-1.0	mW/°C
	Junction temperature	Tj	125	°C
	Forward current	I _{FD}	50	μΑ
Detector	Reverse voltage	V_{RD}	10	V
Dete	Output power dissipation	Po	0.5	mW
	Junction temperature	Tj	125	°C
Stor	age temperature range	T _{stg}	-55 to 125	°C
Оре	rating temperature range	T _{opr}	-40 to 85	°C
Lea (10	d soldering temperature s)	T _{sol}	260	°C
	ation voltage , 60 s, R.H. ≤ 60%) (Note 1)	BVS	2500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two terminal device: Pins 1, 2 and 3 shorted together, and pins 4 and 6 shorted together.

Recommended Operating Conditions

Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	lF	_	20	25	mA
Operating temperature	Topr	-25	_	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device.

Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

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Electrical Characteristics (Ta = 25°C)

	Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	I _F = 10 mA	1.2	1.4	1.7	V
LED	Reverse current	IR	V _R = 3 V	_	_	10	μΑ
	Capacitance	Ст	V = 0V, f = 1 MHz	_	30	60	pF
Detector	Forward voltage	VFD	I _{FD} = 10 μA	_	7	_	V
Dete	Reverse current	I _{RD}	V _{RD} = 10 V		1	_	nA

Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Open voltage	Voc	IF = 10 mA	7.0	8.0		٧
Short current	Isc	IF = 10 mA	12	20	_	μΑ

Isolation Characteristics (Ta = 25°C)

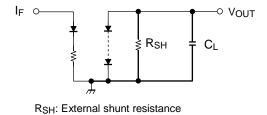
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	V _S = 0V, f = 1 MHz	_	0.8	_	pF
Isolation resistance	Rs	Vs = 500 V, R.H. ≤ 60%	5×10 ¹⁰	10 ¹⁴	_	Ω
Isolation voltage		AC, 60 s	2500	_	_	Vrms
	BVS	AC, 1 s, in oil	$ \begin{array}{c cccc} & - & 0.8 \\ \hline & 5 \times 10^{10} & 10^{14} \end{array} $			vims
		DC, 60 s, in oil	_	5000	_	Vdc

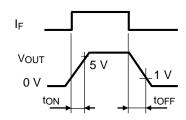
Switching Characteristics (Ta = 25°C)

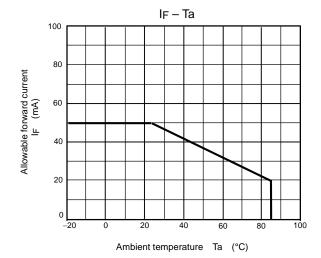
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	ton	I_F = 20 mA, R_{SH} = 510 kΩ	_	0.2	_	ms
Turn-off time	tOFF	C _L =1000 pF (Note 2)	_	1	1	ms

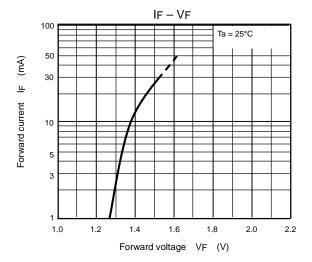
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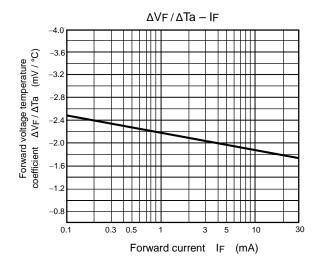
Note 2: Switching time test circuit

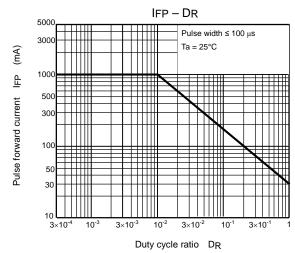


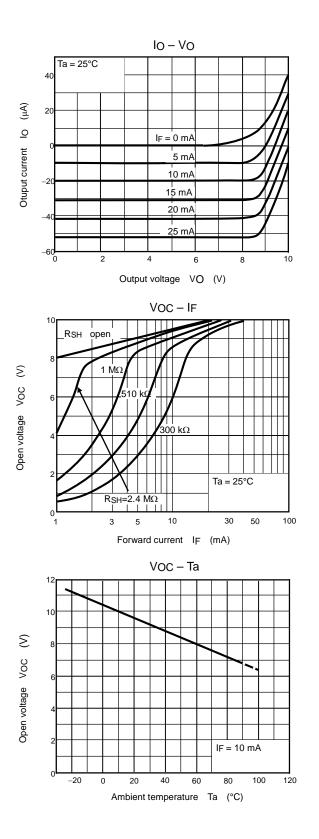


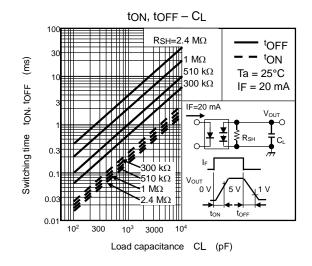


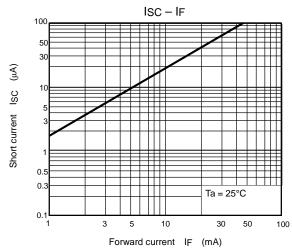


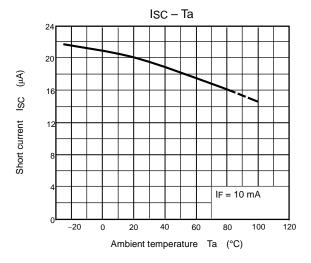












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